

Product End-of-Life Instructions

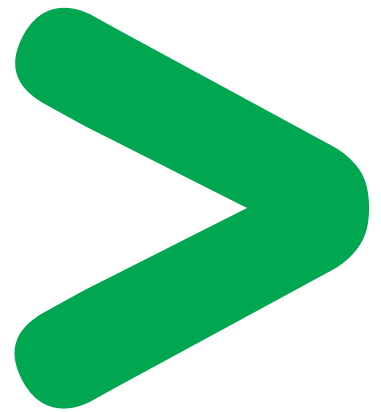
Modicon TM7 - IP67 Distributed I/O

Product Range

Modicon TM7 - IP67 Distributed I/O

Marketing Model

TM7N●●●● / TM7B●●●●



Size in mm:

H x L x D : 27 x 150 x 50

Weight (excluding packaging) in g:

400

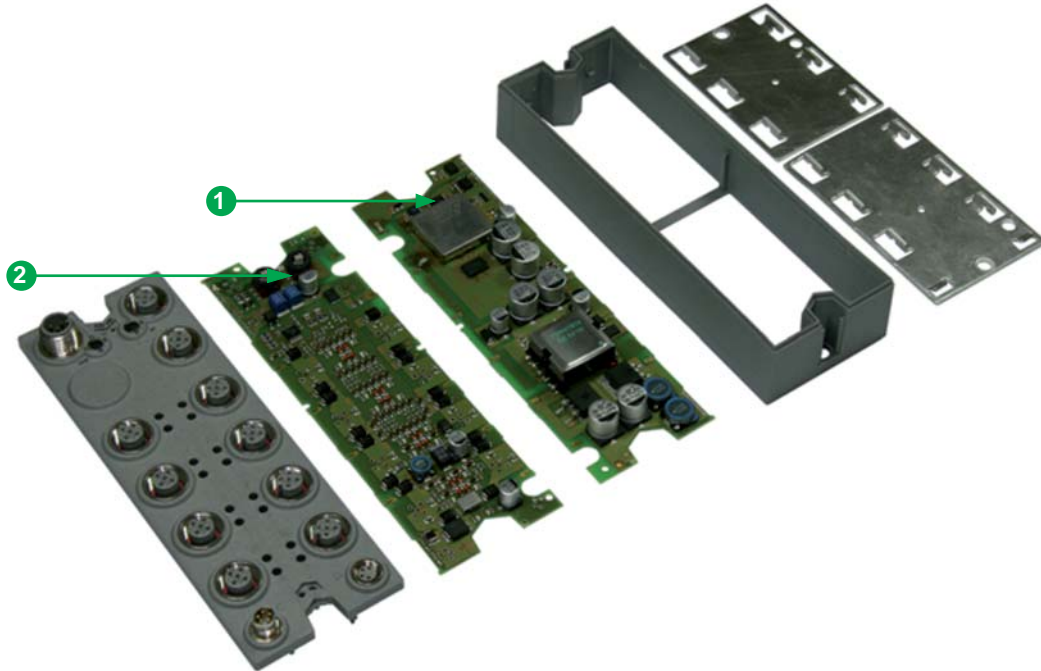


Operations recommended for the end of life treatment

There are several steps to process the products at the end of life so as to recover components, materials or energy :

Reuse ⇒ Separation for special treatment ⇒ Other Dismantling ⇒ Shredding

The components of the products that optimize the recycling performances are listed, identified and located hereunder.



Recommendation	Number on drawing	Components	Weight (g)	Comment
Depollution	1	Printed Circuit Board Assembly (PCBA)	54.5	–
	2	Printed Circuit Board Assembly (PCBA)	30.1	–

Schneider Electric Industries SAS

35, rue Joseph Monier
CS30323
F - 92506 Rueil Malmaison Cedex

RCS Nanterre 954 503 439
Capital social 896 313 776 €
www.schneider-electric.com

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